TEXAS INSTRUMENTS
BQ7718
JAJSEB6L – DECEMBER 2012 – REVISED JUNE 2021

BQ7718 2 直列～5 直列セルのリチウムイオン・バッテリ用過電圧保護、内部遅延タイマ付き

1 特長

- 2、3、4、5 直列セルの過電圧保護
- 内部遅延タイマ
- 固定 OVP スレッショルド
- 高精度の過電圧保護:
  ±10mV
- 低消費電力 I_{CC} ≈ 1μA
  ($V_{CELL(ALL)}$ < $V_{PROTECT}$)
- セル入力あたりのリーク電流が低い:100nA 未満
- 機能安全対応
  - 機能安全システムの設計に役立つ資料を利用可能
- パッケージの占有面積オプション:
  - 小型の 8 ピン QFN (3.00mm × 4.00mm)
  - リード付き 8 ピン MSOP (3.00mm × 5.00mm、リードを含む)

2 アプリケーション

- 次のものに使用されるリチウムイオン・バッテリ・パックの保護:
  - ハンドヘルド園芸用器具
  - ハンドヘルド電動工具
  - コードレス真空掃除機
  - UPS バッテリ・バックアップ
  - 軽量電動車両(電動自転車、電動スクーター、ペダル・アシスト自転車)

3 概要

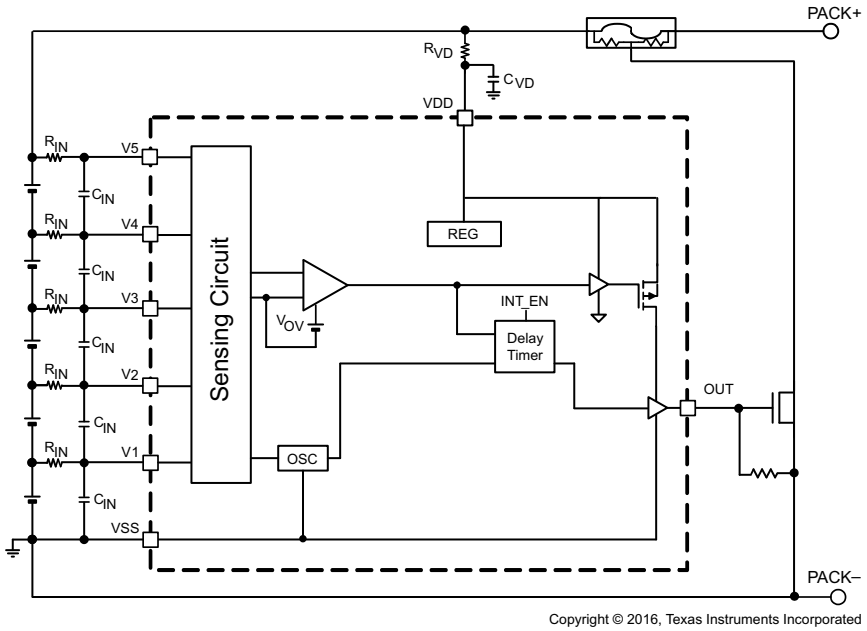
BQ7718xy 製品ファミリは、リチウムイオン・バッテリ・パック・システム用の過電圧モニタおよびプロテクタを提供します。各セルの過電圧状況を個別に監視できます。生産ライン・テストを迅速に行えるよう、BQ7718xy デバイスは遅延時間を大幅に削減したカスタマ・テスト・モード (CTM) を備えています。

BQ7718xy デバイスでは、いずれかのセルで過電圧状態が検出されると、内部遅延タイマが起動します。遅延タイマが満了すると、出力はアクティブ状態へとトリガされます (構成により HIGH または LOW)。

「製品情報」の表

部品番号	パッケージ	本体サイズ (公称)
BQ771800(1)	DPJ (8)	3.00mm × 4.00mm
BQ771800(2)	DGK (8)	3.00mm × 3.00mm (3.00mm × 5.00mm、リード含む)

(1) 利用可能なカタログ・パッケージについては、このデータシートの末尾にある注文情報および *セクション 5* を参照してください。
(2) 詳細は TI までお問い合わせください。



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概略回路図

英語版の TI 製品についての情報を翻訳したこの資料は、製品の概要を確認する目的で便宜的に提供しているものです。該当する正式な英語版の最新情報は、www.ti.com で閲覧でき、その内容が常に優先されます。TI では翻訳の正確性および妥当性につきましては一切保証いたしません。実際の設計などの前には、必ず最新版の英語版をご参照くださいますようお願いいたします。

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4 Revision History

資料番号末尾の英字は改訂を表しています。その改訂履歴は英語版に準じています。

Changes from Revision K (April 2021) to Revision L (June 2021) — **Page**

- Changed the BQ771825 device to Production Data ... 3

Changes from Revision J (September 2020) to Revision K (June 2021) — **Page**

- Added the BQ771825 device to the *Device Comparison Table* ... 3

Changes from Revision I (July 2020) to Revision J (September 2020) — **Page**

- Added the BQ771824 device to the *Device Comparison Table* ... 3
- Added BQ771824 to the *DC Characteristics* ... 6
- Added BQ771824 delay settings ... 7

Changes from Revision H (February 2020) to Revision I (July 2020) — **Page**

- 機能安全対応機能を追加 ... 1
- Added the BQ771823 device to the *Device Comparison Table* ... 3
- Added BQ771823 to the *DC Characteristics* ... 6
- Added BQ771823 delay settings to *セクション 7.6* ... 7

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5 Device Comparison Table

T_A	Part Number	Package	Package Designator	OVP (V)	OV Hysteresis (V)	Output Delay	Output Drive	Tape and Reel (Large)	Tape and Reel (Small)
–40°C to 110°C	BQ771800	8-Pin QFN or 8-Pin MSOP	DPJ/DGK	4.300	0.300	4 s	CMOS Active High	BQ771800DPJR	BQ771800DPJT
	BQ771801			4.275	0.050	3 s	NCH Active Low, Open Drain	BQ771801DPJR	BQ771801DPJT
	BQ771802			4.225	0.300	1 s	NCH Active Low, Open Drain	BQ771802DPJR	BQ771802DPJT
	BQ771803			4.275	0.050	1 s	NCH Active Low, Open Drain	BQ771803DPJR	BQ771803DPJT
								BQ771803DGKR(2)	BQ771803DGKT(2)
	BQ771806			4.350	0.300	3 s	CMOS Active High	BQ771806DPJR	BQ771806DPJT
	BQ771807			4.450	0.300	3 s	CMOS Active High	BQ771807DPJR	BQ771807DPJT
	BQ771808			4.200	0.050	1 s	NCH Active Low, Open Drain	BQ771808DPJR	BQ771808DPJT
	BQ771809			4.200	0.050	1 s	CMOS Active High	BQ771809DPJR	BQ771809DPJT
	BQ771811			4.225	0.050	1 s	CMOS Active High	BQ771811DPJR	BQ771811DPJT
	BQ771815			4.225	0.050	1 s	NCH Active Low, Open Drain	BQ771815DPJR	BQ771815DPJT
	BQ771817			4.275	0.050	1 s	CMOS Active High	BQ771817DPJR	BQ771817DPJT
	BQ771818			4.300	0.300	1 s	CMOS Active High	BQ771818DPJR	BQ771818DPJT
								BQ771818DGKR	BQ771818DGKT
	BQ771823			4.275	0.300	3 s	NCH Active Low, Open Drain	BQ771823DPJR	—
	BQ771824			3.850	0.300	4 s	CMOS Active High	BQ771824DPJR	—
	BQ771825			3.950	0.050	3 s	NCH Active Low, Open Drain	BQ771825DPJR	BQ771825DPJT
								BQ771825DGKR(2)	BQ771825DGKT(2)
	BQ7718xy(1)			3.850 – 4.650	Latch, 0.05, 0.25, 0.3	1, 4, 3, 5.5 s	NCH, Active Low, Open Drain, CMOS Active High	BQ7718xyDPJR	BQ7718xyDPJT

(1) Future option. Contact TI for more information.
(2) Contact TI for more information.

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6 Pin Configuration and Functions

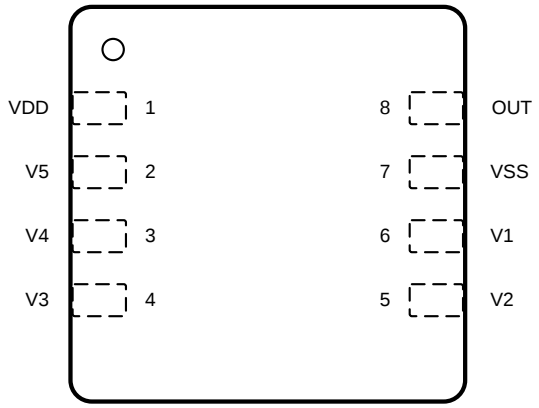


図 6-1. DPJ Package 8-Pin (WSON) Top View

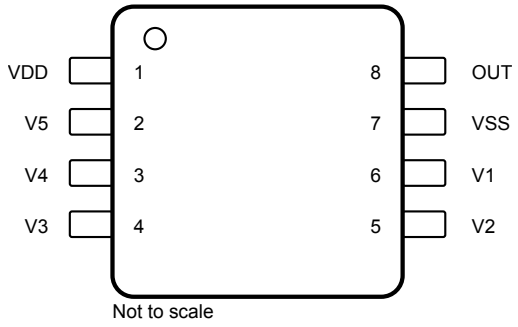


図 6-2. DGK Package 8-Pin (PDSO) Top View

表 6-1. Pin Functions

NO.	NAME	TYPE I/O	DESCRIPTION
1	VDD	P	Power supply
2	V5	I	Sense input for positive voltage of the fifth cell from the bottom of the stack
3	V4	I	Sense input for positive voltage of the fourth cell from the bottom of the stack
4	V3	I	Sense input for positive voltage of the third cell from the bottom of the stack
5	V2	I	Sense input for positive voltage of the second cell from the bottom of the stack
6	V1	I	Sense input for positive voltage of the lowest cell in the stack
7	VSS	P	Electrically connected to IC ground and negative terminal of the lowest cell in the stack
8	OUT	O	Output drive for overvoltage fault signal
O = Output, I = Input, P = Power connection			

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7 Specifications

7.1 Absolute Maximum Ratings

Over-operating free-air temperature range (unless otherwise noted)(1)

		MIN	MAX	UNIT
Supply voltage range	VDD – VSS	–0.3	30	V
Input voltage range	V5 – VSS or V4 – VSS or V3 – VSS or V2 – VSS or V1 – VSS	–0.3	30	V
Output voltage range	OUT – VSS	–0.3	30	V
Continuous total power dissipation, P_{TOT}		See セクション 7.4.		
Functional temperature		–40	110	°C
Storage temperature range, T_{STG}		–65	150	°C

(1) Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum–rated conditions for extended periods may affect device reliability.

7.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$ Rating	Electrostatic discharge	Human body model (HBM) ESD stress voltage(1)	±2000	V
		Charged device model (CDM) ESD stress voltage(2)	±500	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

Over-operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
Supply voltage, V_{DD} (1)		3	25	V
Input voltage range	V5–V4 or V4–V3 or V3–V2 or V2–V1 or V1–VSS	0	5	V
Operating ambient temperature range, T_A		–40	110	°C

(1) See セクション 9.2.

7.4 Thermal Information

THERMAL METRIC(1)		BQ7718xy DPJ (WSON) 8 PINS	UNIT
$R_{\theta JA}$	Junction-to-ambient thermal resistance	56.6	°C/W
$R_{\theta JCtop}$	Junction-to-case(top) thermal resistance	56.4	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	30.6	°C/W
ψ_{JT}	Junction-to-top characterization parameter	1.0	°C/W
ψ_{JB}	Junction-to-board characterization parameter	37.8	°C/W
$R_{\theta JCbot}$	Junction-to-case(bottom) thermal resistance	11.3	°C/W

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report.

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7.5 DC Characteristics

Typical values stated where T_A = 25°C and V_{DD} = 18 V, MIN/MAX values stated where T_A = –40°C to 110°C and V_{DD} = 3 V to 25 V (unless otherwise noted).

SYMBOL	PARAMETER	CONDITION	MIN	TYP	MAX	UNIT
Voltage Protection Threshold VCx						
V_{OV}	$V_{(PROTECT)}$ Overvoltage Detection	BQ771800		4.300		V
		BQ771801		4.275		V
		BQ771803		4.275		V
		BQ771802		4.225		V
		BQ771806		4.350		V
		BQ771807		4.450		V
		BQ771808		4.200		V
		BQ771809		4.200		V
		BQ771811		4.225		V
		BQ771815		4.225		V
		BQ771817		4.275		V
		BQ771818		4.300		V
		BQ771823		4.275		V
		BQ771824		3.850		V
V_{HYS}	OV Detection Hysteresis	BQ771800	250	300	400	mV
		BQ771801	0	50	100	mV
		BQ771802	250	300	400	mV
		BQ771803	0	50	100	mV
		BQ771806	250	300	400	mV
		BQ771807	250	300	400	mV
		BQ771808	0	50	100	mV
		BQ771809	0	50	100	mV
		BQ771811	0	50	100	mV
		BQ771815	0	50	100	mV
		BQ771817	0	50	100	mV
		BQ771818	250	300	400	mV
		BQ771823	250	300	400	mV
		BQ771824	250	300	400	mV
V_{OA}	OV Detection Accuracy	T_A = 25°C	–10		10	mV
$V_{OADRIFT}$	OV Detection Accuracy Across Temperature	T_A = –40°C	–40		44	mV
		T_A = 0°C	–20		20	mV
		T_A = 60°C	–24		24	mV
		T_A = 110°C	–54		54	mV
Supply and Leakage Current						
I_{CC}	Supply Current	(V5–V4) = (V4–V3) = (V3–V2) = (V2–V1) = (V1–VSS) = 4 V (See 図 8-2.)		1	2	µA
I_{IN}	Input Current at Vx Pins	(V5–V4) = (V4–V3) = (V3–V2) = (V2–V1) = (V1–VSS) = 4 V (See 図 8-2.)	–0.1		0.1	µA

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Typical values stated where T_A = 25°C and V_{DD} = 18 V, MIN/MAX values stated where T_A = –40°C to 110°C and V_{DD} = 3 V to 25 V (unless otherwise noted).

SYMBOL	PARAMETER	CONDITION	MIN	TYP	MAX	UNIT
Output Drive OUT, CMOS Active HIGH Versions Only						
V_{OUT1}	Output Drive Voltage, Active High	(V5–V4), (V4–V3), (V3–V2), (V2–V1), or (V1–VSS) > V_{OV}, VDD = 18 V, I_{OH} = 100 µA	6			V
		If three of four cells are short circuited and only one cell remains powered and > V_{OV}, VDD = Vx (cell voltage), I_{OH} = 100 µA		VDD – 0.3		V
		(V5–V4), (V4–V3), (V3–V2), (V2–V1), and (V1–VSS) < V_{OV}, VDD = 18 V, I_{OL} = 100 µA measured into pin		250	400	mV
I_{OUTH1}	OUT Source Current (during OV)	(V5–V4), (V4–V3), (V3–V2), (V2–V1), or (V1–VSS) > V_{OV}, VDD = 18 V. OUT = 0 V. Measured out of OUT pin			4.5	mA
I_{OUTL1}	OUT Sink Current (no OV)	(V5–V4), (V4–V3), (V3–V2), (V2–V1), and (V1–VSS) < V_{OV}, VDD = 18 V, OUT = VDD. Measured into OUT pin	0.5		14	mA
Output Drive OUT, NCH Open Drain Active LOW Versions Only						
V_{OUT2}	Output Drive Voltage, Active Low	(V5–V4), (V4–V3), (V3–V2), (V2–V1), or (V1–VSS) > V_{OV}, VDD = 18 V, I_{OL} = 100 µA measured into OUT pin		250	400	mV
I_{OUTH2}	OUT Sink Current (during OV)	(V5–V4), (V4–V3), (V3–V2), (V2–V1), or (V1–VSS) > V_{OV}, VDD = 18 V. OUT = VDD. Measured into OUT pin	0.5		14	mA
I_{OUTL2}	OUT Source Current (no OV)	(V5–V4), (V4–V3), (V3–V2), (V2–V1), and (V1–VSS) < V_{OV}, VDD = 18 V. OUT = VDD. Measured out of OUT pin			100	nA

7.6 Timing Requirements

			MIN	NOM	MAX	UNIT
Delay Timer						
t_{DELAY}	OV Delay Time	BQ771800, BQ771824	3.2	4	4.8	s
		BQ771801, BQ771807, BQ771823	2.4	3	3.6	s
		BQ771802, BQ771803, BQ771811, BQ771815, BQ771818	0.8	1	1.2	s
		Preview option only. Contact TI.	4.4	5.5	6.6	s
$X_{CTMDELAY}$	Fault Detection Delay Time during Customer Test Mode	See セクション 8.4.3.		15		ms

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7.7 Typical Characteristics

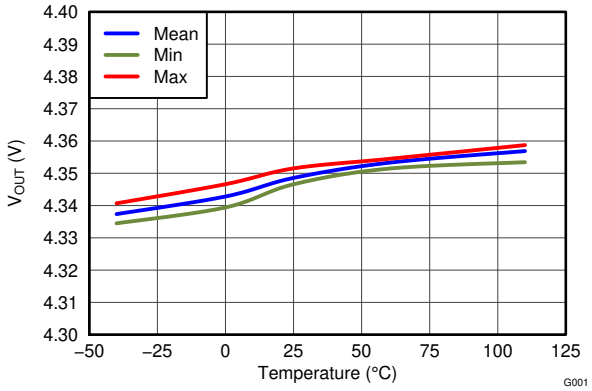


図 7-1. Overvoltage Threshold (OVT) vs. Temperature

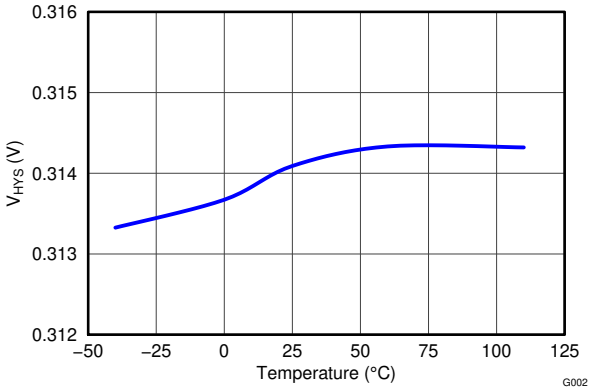


図 7-2. Hysteresis V_{HYS} vs. Temperature

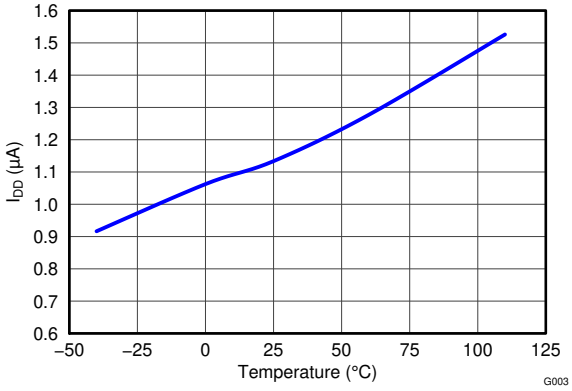


図 7-3. I_{DD} Current Consumption vs. Temperature at VDD = 16 V

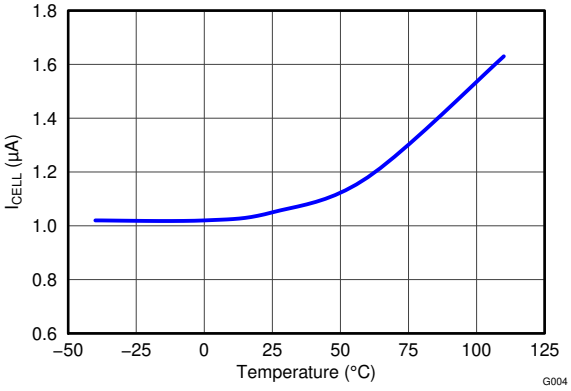


図 7-4. I_{CELL} vs. Temperature at V_{CELL}= 9.2 V

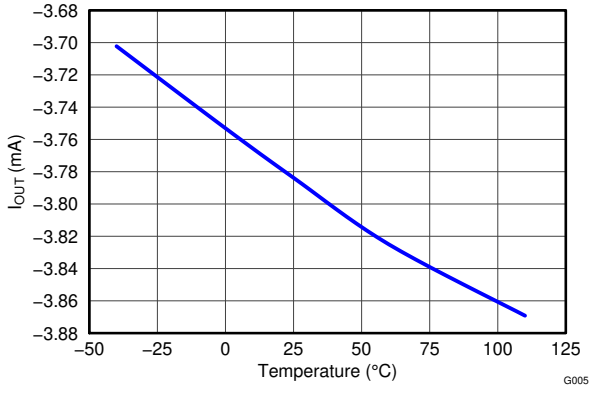


図 7-5. Output Current I_{OUT} vs. Temperature

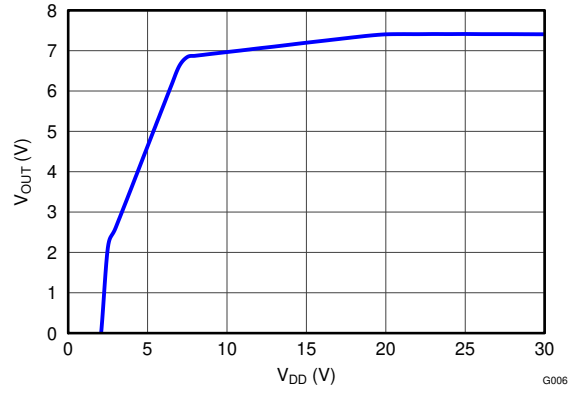


図 7-6. V_{OUT} vs. V_{DD}

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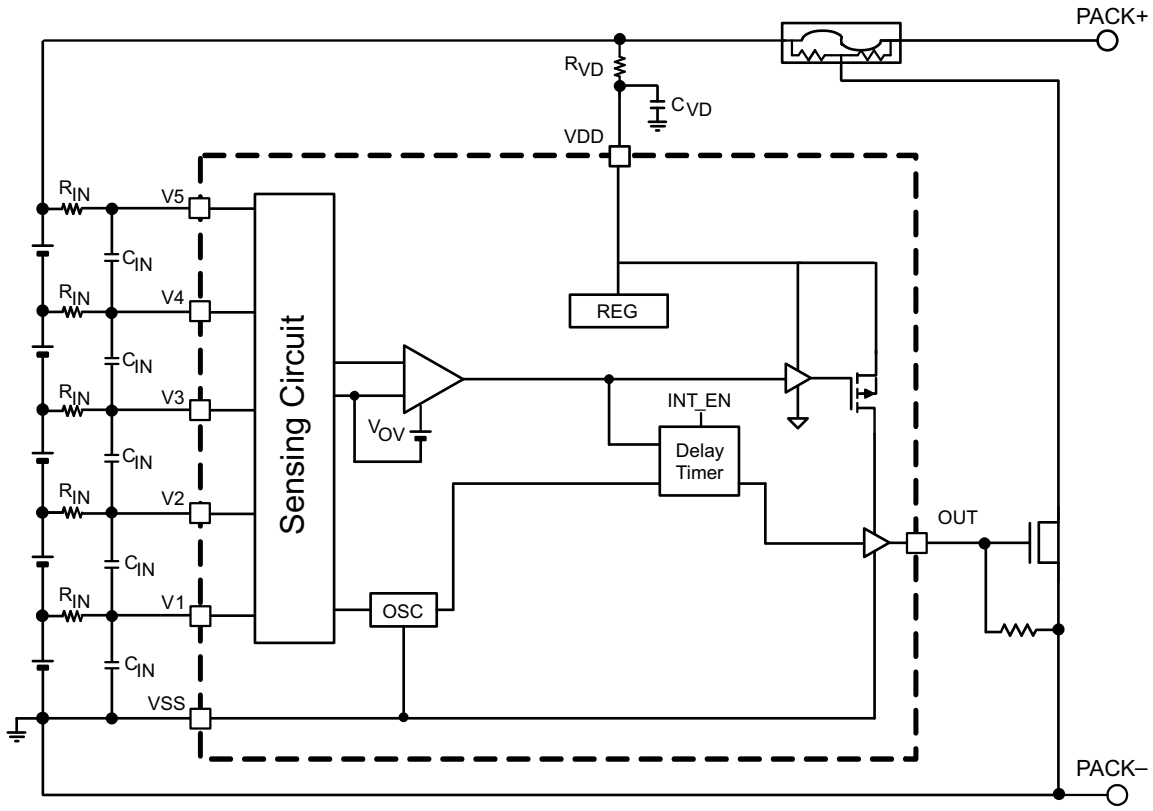
8 Detailed Description

8.1 Overview

In the BQ7718xy family of devices, each cell is monitored independently and an external delay timer is initiated if an overvoltage condition is detected on any cell.

For quicker production-line testing, the device provides a Customer Test Mode with greatly reduced delay time.

8.2 Functional Block Diagram



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8.3 Feature Description

In the BQ7718xy device, each cell is monitored independently. Overvoltage is detected by comparing the actual cell voltage to a protection voltage reference, V_{OV}. If any cell voltage exceeds the programmed OV value, a timer circuit is activated. When the timer expires, the OUT pin goes from inactive to active state.

For NCH Open Drain Active Low configurations, the OUT pin pulls down to VSS when active (OV present) and is high impedance when inactive (no OV).

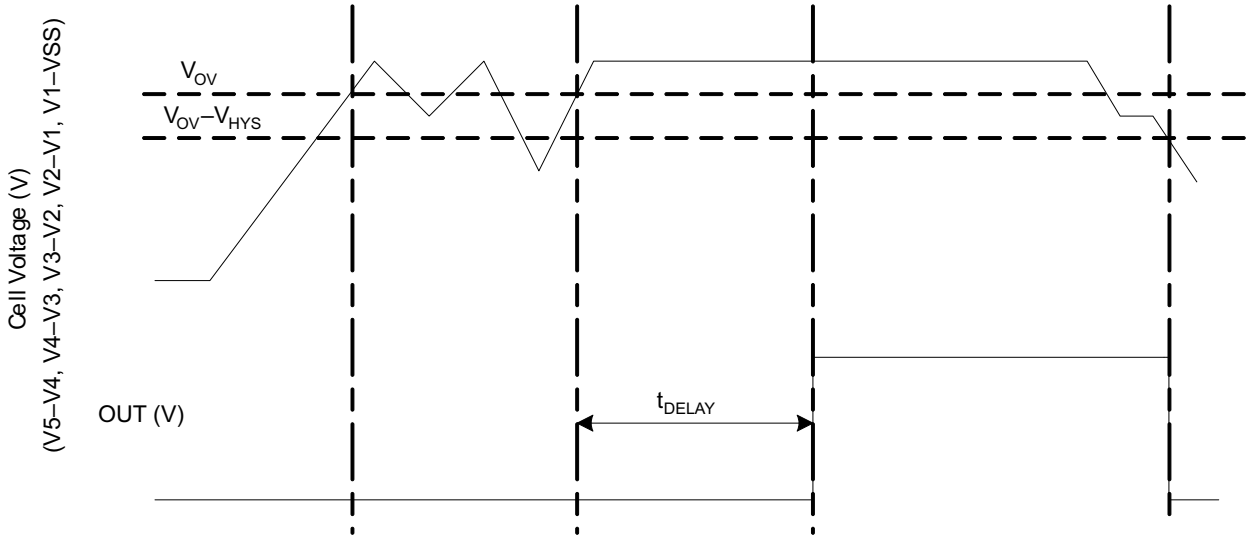


図 8-1. Timing for Overvoltage Sensing

8.3.1 Sense Positive Input for Vx

This is an input to sense each single battery cell voltage. A series resistor and a capacitor across the cell for each input is required for noise filtering and stable voltage monitoring.

8.3.2 Output Drive, OUT

This pin serves as the fault signal output, and may be ordered in either active HIGH or LOW options.

8.3.3 Supply Input, VDD

This pin is the unregulated input power source for the IC. A series resistor is connected to limit the current, and a capacitor is connected to ground for noise filtering.

8.4 Device Functional Modes

8.4.1 NORMAL Mode

When all of the cell voltages are below the overvoltage threshold, V_{OV}, the device operates in NORMAL mode. The device monitors the differential cell voltages connected across (V1 – VSS), (V2 – V1), (V3 – V2), (V4 – V3), and (VC4 – VC5). The OUT pin is inactive and if configured:

The OUT pin is inactive and if configured:

- Active high is low.
- Active low is being externally pulled up and is an open drain.

8.4.2 OVERVOLTAGE Mode

OVERVOLTAGE mode is detected if any of the cell voltages exceeds the overvoltage threshold, V_{OV} for configured OV delay time. The OUT pin is activated after a delay time set by the capacitance in the CD pin. The OUT pin will either pull high internally, if configured as active high, or will be pulled low internally, if configured as active low. When all of the cell voltages fall below the (V_{OV} – V_{HYS}), the device returns to NORMAL mode.

8.4.3 Customer Test Mode

Customer Test Mode (CTM) helps to reduce test time for checking the overvoltage delay timer parameter once the circuit is implemented in the battery pack. To enter CTM, VDD should be set to at least 10 V higher than V5 (see 図 8-2). The delay timer is greater than 10 ms, but considerably shorter than the timer delay in normal operation. To exit Customer Test Mode, remove the VDD to a V5 voltage differential of 10 V so that the decrease in this value automatically causes an exit.

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CAUTION

Avoid exceeding any Absolute Maximum Voltages on any pins when placing the part into Customer Test Mode. Also avoid exceeding Absolute Maximum Voltages for the individual cell voltages (V5–V4), (V4–V3), (V4–V3), (V3–V2), (V2–V1), and (V1–VSS). Stressing the pins beyond the rated limits may cause permanent damage to the device.

図 8-2 shows the timing for the Customer Test Mode.

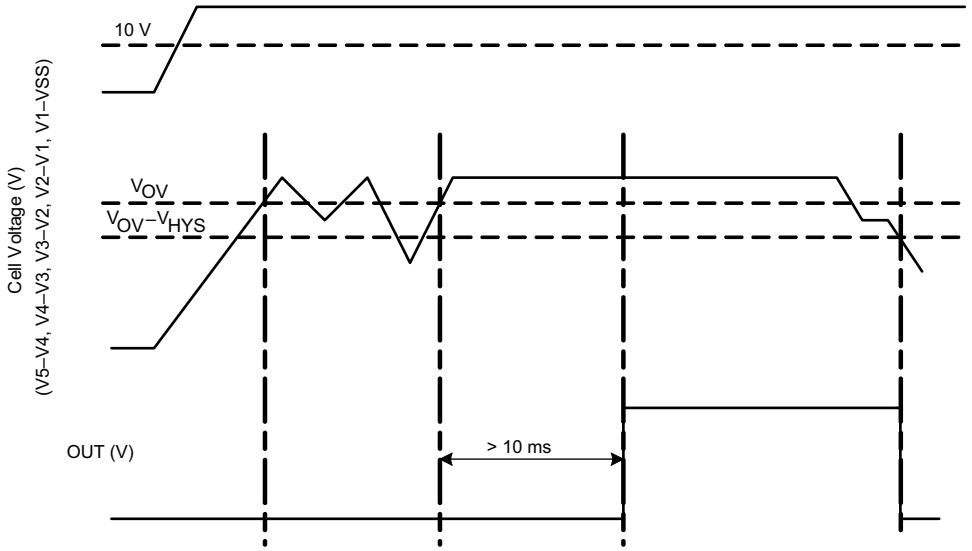


図 8-2. Timing for Customer Test Mode

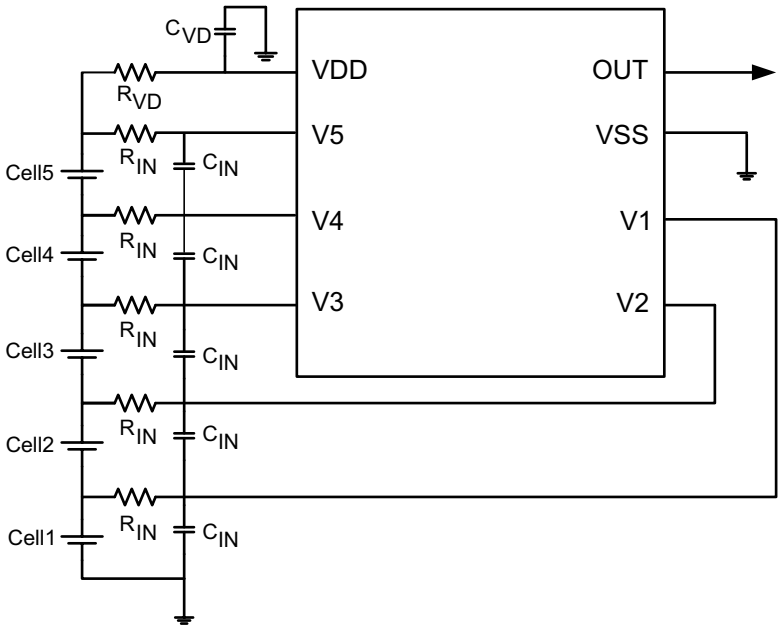
9 Application and Implementation

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

In the case of an Open Drain Active Low configuration, an external pull-up resistor is required on the OUT pin. Changes to the ranges stated in 表 9-1 will impact the accuracy of the cell measurements.



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図 9-1. Application Configuration

9.1.1 Design Requirements

Changes to the ranges stated in 表 9-1 will impact the accuracy of the cell measurements. 図 9-1 shows each external component.

表 9-1. Parameters

PARAMETER	EXTERNAL COMPONENT	MIN	NOM	MAX	UNIT
Voltage monitor filter resistance	R_{IN}	900	1000	1100	Ω
Voltage monitor filter capacitance	C_{IN}	0.01		0.1	µF
Supply voltage filter resistance	R_{VD}	100		1K	Ω
Supply voltage filter capacitance	C_{VD}		0.1		µF
CD external delay capacitance			0.1	1	µF
OUT Open drain version pull-up resistance to PACK+			100		kΩ

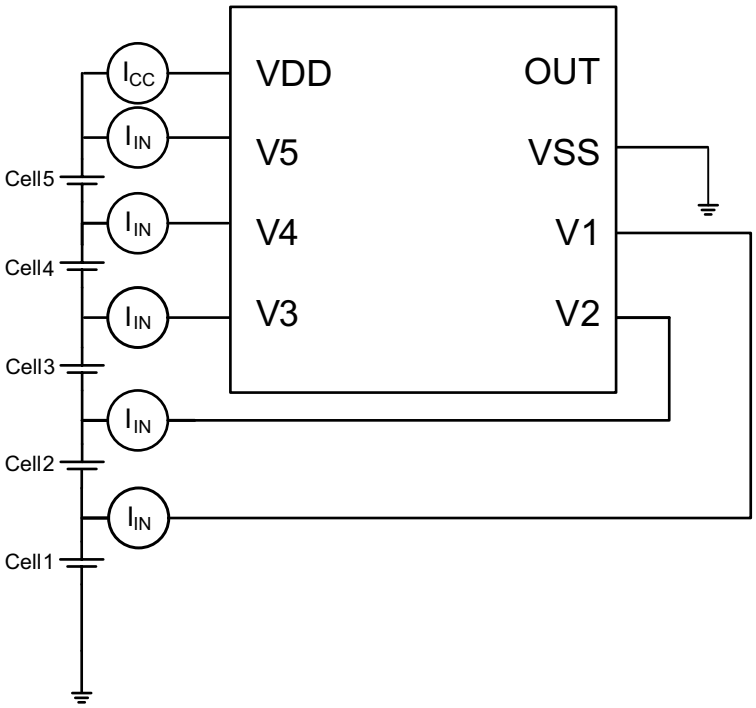
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Note

The device is calibrated using an R_{IN} value = 1 kΩ. Using a value other than this recommended value changes the accuracy of the cell voltage measurements and V_{OV} trigger level.

9.1.2 Detailed Design Procedure

図 9-2 shows the measurement for current consumption for the product for both VDD and Vx.



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図 9-2. Configuration for IC Current Consumption Test

9.1.2.1 Application Curves

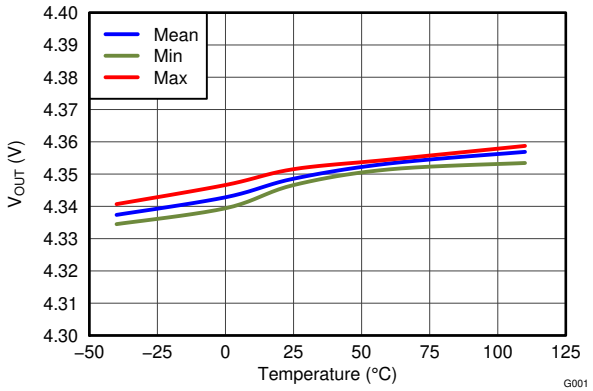


図 9-3. Overvoltage Threshold (OVT) vs. Temperature

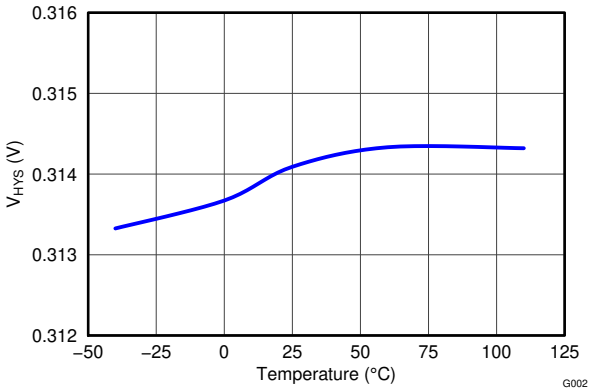


図 9-4. Hysteresis V_{HYS} vs. Temperature

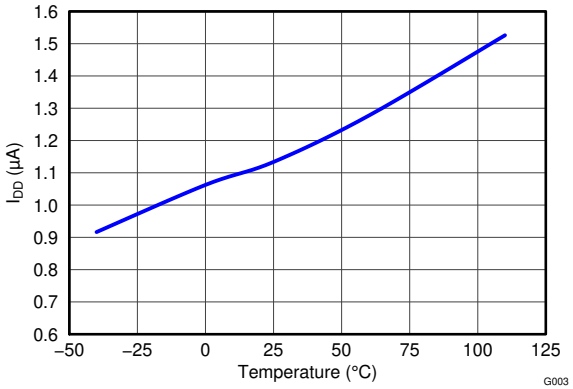


図 9-5. I_{DD} Current Consumption vs. Temperature at VDD = 16 V

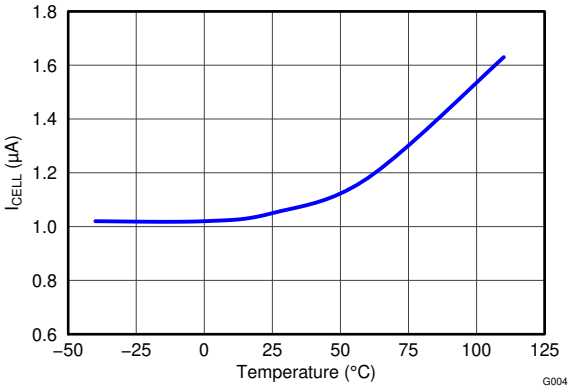


図 9-6. I_{CELL} vs. Temperature at V_{CELL}= 9.2 V

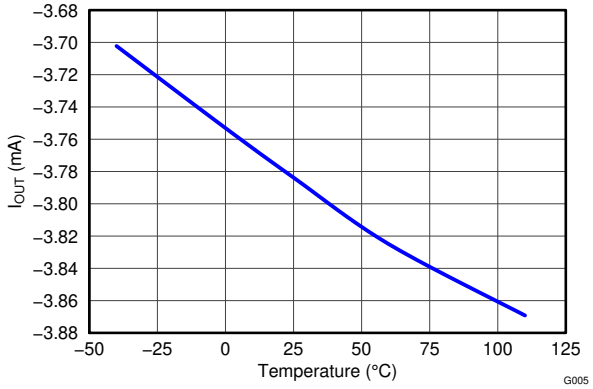


図 9-7. Output Current I_{OUT} vs. Temperature

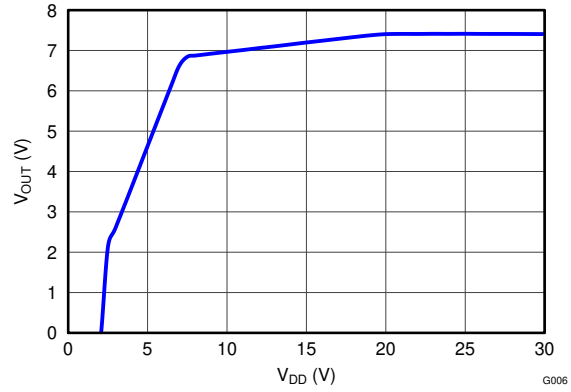


図 9-8. V_{OUT} vs. V_{DD}

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9.2 Systems Examples

In these application examples, an external pull-up resistor is required on the OUT pin to configure for an Open Drain Active Low operation.

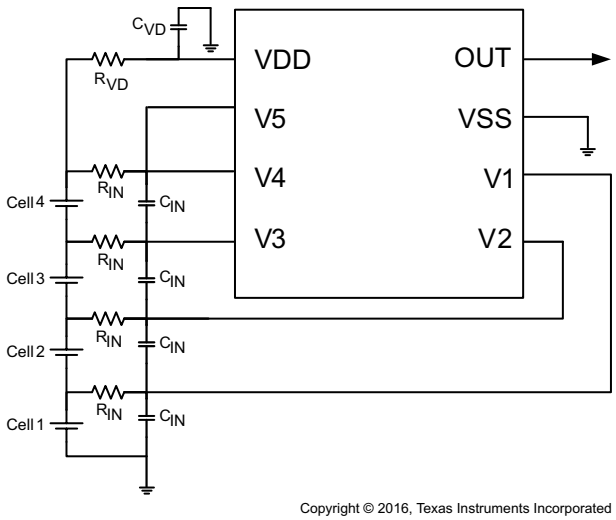


図 9-9. 4-Series Cell Configuration

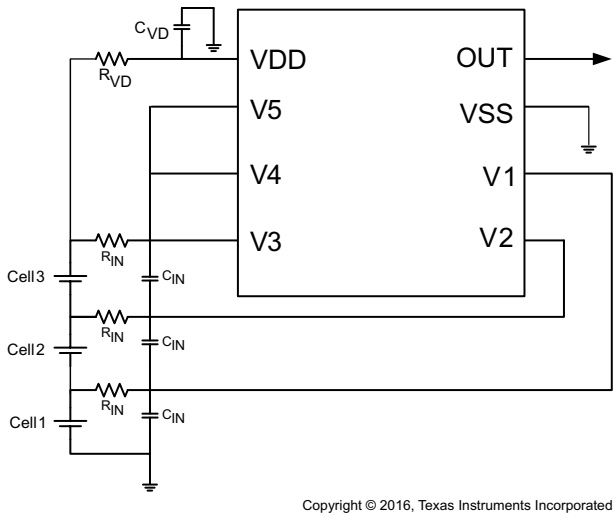


図 9-10. 3-Series Cell Configuration with Fixed Delay

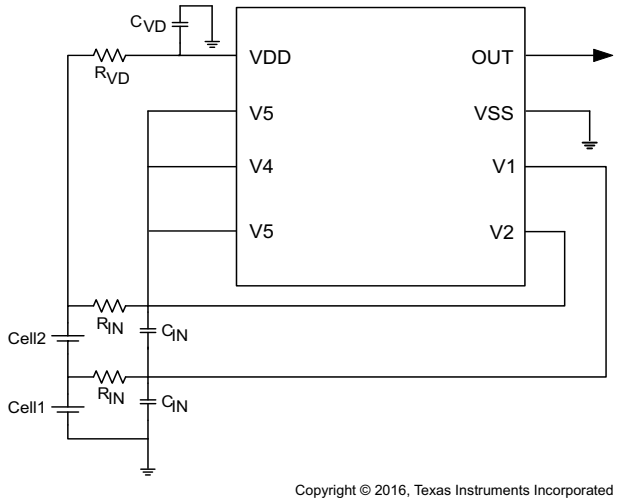


図 9-11. 2-Series Cell Configuration with Internal Fixed Delay

10 Power Supply Recommendations

The maximum power of this device is 25 V on VDD.

11 Layout

11.1 Layout Guidelines

- Ensure the RC filters for the V1 and VDD pins are placed as close as possible to the target terminal.
- The VSS pin should be routed to the CELL– terminal.

11.2 Layout Example

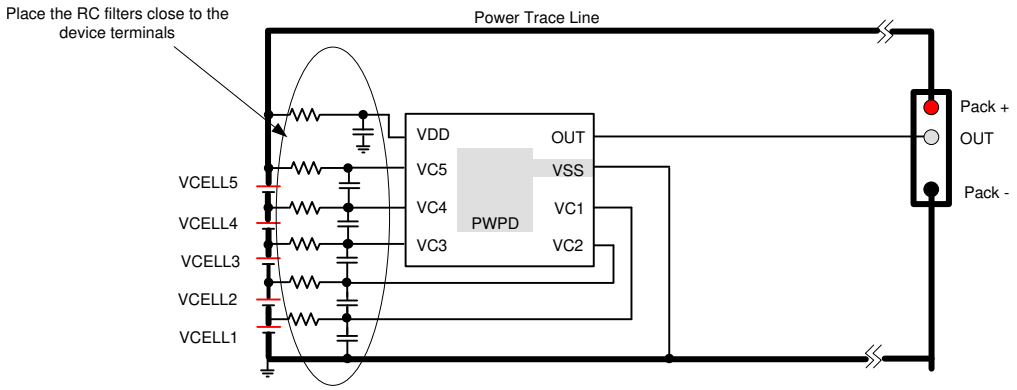


図 11-1. Example Layout

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12 Device and Documentation Support

12.1 Documentation Support

For additional information, see the BQ7718 technical documentation, including the documentation available to aid functional safety system design.

12.2 Third-Party Products Disclaimer

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12.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

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12.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

12.7 Glossary

TI Glossary	This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
BQ771800DPJR	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771800
BQ771800DPJR.A	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771800
BQ771800DPJT	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771800
BQ771800DPJT.A	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771800
BQ771801DPJR	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771801
BQ771801DPJR.A	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771801
BQ771801DPJT	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771801
BQ771801DPJT.A	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771801
BQ771802DPJR	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771802
BQ771802DPJR.A	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771802
BQ771802DPJT	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771802
BQ771802DPJT.A	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771802
BQ771803DPJR	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771803
BQ771803DPJR.A	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771803
BQ771803DPJT	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771803
BQ771803DPJT.A	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771803
BQ771806DPJR	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771806
BQ771806DPJR.A	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771806
BQ771806DPJT	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771806
BQ771806DPJT.A	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771806
BQ771807DPJR	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771807
BQ771807DPJR.A	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771807
BQ771807DPJT	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771807
BQ771807DPJT.A	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771807
BQ771808DPJR	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771808
BQ771808DPJR.A	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771808
BQ771808DPJT	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771808
BQ771808DPJT.A	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771808
BQ771809DPJR	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771809

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
BQ771809DPJR.A	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771809
BQ771809DPJT	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771809
BQ771809DPJT.A	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771809
BQ771811DPJR	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771811
BQ771811DPJR.A	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771811
BQ771811DPJT	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771811
BQ771811DPJT.A	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771811
BQ771815DPJR	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771815
BQ771815DPJR.A	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771815
BQ771815DPJT	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771815
BQ771815DPJT.A	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771815
BQ771817DPJR	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771817
BQ771817DPJR.A	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771817
BQ771817DPJT	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771817
BQ771817DPJT.A	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771817
BQ771818DPJR	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771818
BQ771818DPJR.A	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771818
BQ771818DPJT	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	771818
BQ771818DPJT.A	Active	Production	WSON (DPJ) | 8	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	771818
BQ771823DPJR	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 110	771823
BQ771823DPJR.A	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 110	771823
BQ771824DPJR	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 110	771824
BQ771824DPJR.A	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 110	771824
BQ771824DPJRG4	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 110	771824
BQ771824DPJRG4.A	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 110	771824
BQ771825DPJR	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	771825
BQ771825DPJR.A	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	771825
BQ771825DPJRG4	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 110	771825
BQ771825DPJRG4.A	Active	Production	WSON (DPJ) | 8	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 110	771825

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

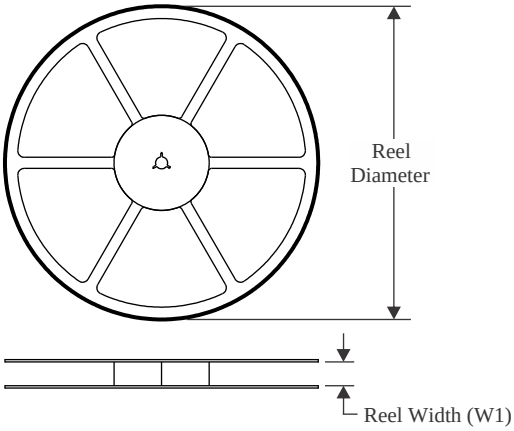
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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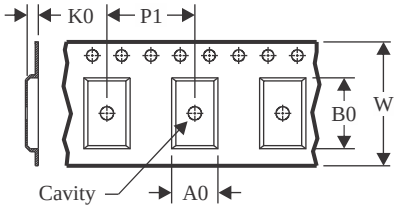
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

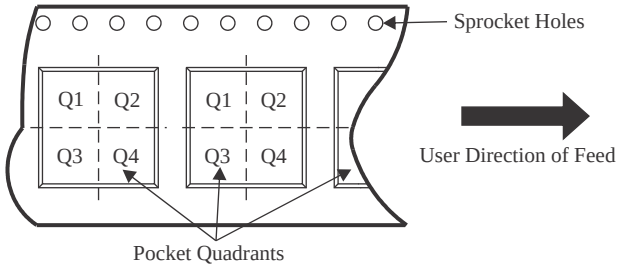


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

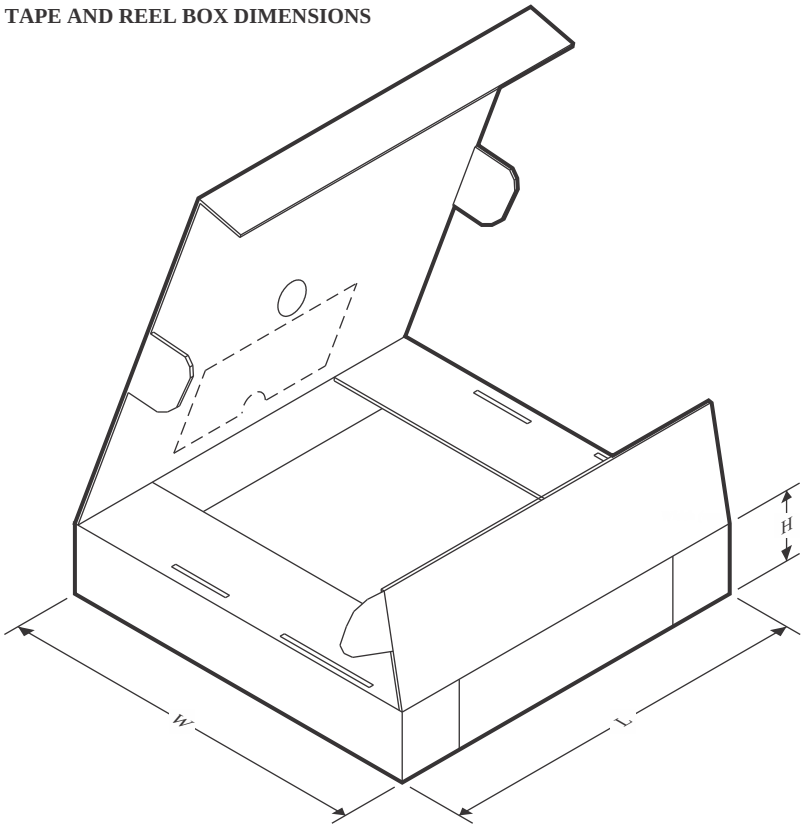


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
BQ771800DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771800DPJT	WSON	DPJ	8	250	180.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771801DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771801DPJT	WSON	DPJ	8	250	180.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771802DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771802DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771802DPJT	WSON	DPJ	8	250	180.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771803DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771803DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771803DPJT	WSON	DPJ	8	250	180.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771806DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771806DPJT	WSON	DPJ	8	250	180.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771807DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771807DPJT	WSON	DPJ	8	250	180.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771808DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771808DPJT	WSON	DPJ	8	250	180.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
BQ771809DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771809DPJT	WSON	DPJ	8	250	180.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771811DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771811DPJT	WSON	DPJ	8	250	180.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771815DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771815DPJT	WSON	DPJ	8	250	180.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771817DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771817DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771817DPJT	WSON	DPJ	8	250	180.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771818DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771818DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771818DPJT	WSON	DPJ	8	250	180.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771823DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771824DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771824DPJRG4	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771825DPJR	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2
BQ771825DPJRG4	WSON	DPJ	8	3000	330.0	12.4	3.3	4.3	1.1	8.0	12.0	Q2

TAPE AND REEL BOX DIMENSIONS



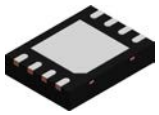
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
BQ771800DPJR	WSON	DPJ	8	3000	335.0	335.0	25.0
BQ771800DPJT	WSON	DPJ	8	250	182.0	182.0	20.0
BQ771801DPJR	WSON	DPJ	8	3000	335.0	335.0	25.0
BQ771801DPJT	WSON	DPJ	8	250	182.0	182.0	20.0
BQ771802DPJR	WSON	DPJ	8	3000	335.0	335.0	25.0
BQ771802DPJR	WSON	DPJ	8	3000	367.0	367.0	35.0
BQ771802DPJT	WSON	DPJ	8	250	182.0	182.0	20.0
BQ771803DPJR	WSON	DPJ	8	3000	335.0	335.0	25.0
BQ771803DPJR	WSON	DPJ	8	3000	367.0	367.0	35.0
BQ771803DPJT	WSON	DPJ	8	250	182.0	182.0	20.0
BQ771806DPJR	WSON	DPJ	8	3000	335.0	335.0	25.0
BQ771806DPJT	WSON	DPJ	8	250	182.0	182.0	20.0
BQ771807DPJR	WSON	DPJ	8	3000	335.0	335.0	25.0
BQ771807DPJT	WSON	DPJ	8	250	182.0	182.0	20.0
BQ771808DPJR	WSON	DPJ	8	3000	335.0	335.0	25.0
BQ771808DPJT	WSON	DPJ	8	250	182.0	182.0	20.0
BQ771809DPJR	WSON	DPJ	8	3000	335.0	335.0	25.0
BQ771809DPJT	WSON	DPJ	8	250	182.0	182.0	20.0

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
BQ771811DPJR	WSON	DPJ	8	3000	335.0	335.0	25.0
BQ771811DPJT	WSON	DPJ	8	250	182.0	182.0	20.0
BQ771815DPJR	WSON	DPJ	8	3000	335.0	335.0	25.0
BQ771815DPJT	WSON	DPJ	8	250	182.0	182.0	20.0
BQ771817DPJR	WSON	DPJ	8	3000	367.0	367.0	35.0
BQ771817DPJR	WSON	DPJ	8	3000	335.0	335.0	25.0
BQ771817DPJT	WSON	DPJ	8	250	182.0	182.0	20.0
BQ771818DPJR	WSON	DPJ	8	3000	346.0	346.0	33.0
BQ771818DPJR	WSON	DPJ	8	3000	367.0	367.0	35.0
BQ771818DPJT	WSON	DPJ	8	250	210.0	185.0	35.0
BQ771823DPJR	WSON	DPJ	8	3000	367.0	367.0	35.0
BQ771824DPJR	WSON	DPJ	8	3000	367.0	367.0	35.0
BQ771824DPJRG4	WSON	DPJ	8	3000	367.0	367.0	35.0
BQ771825DPJR	WSON	DPJ	8	3000	367.0	367.0	35.0
BQ771825DPJRG4	WSON	DPJ	8	3000	367.0	367.0	35.0

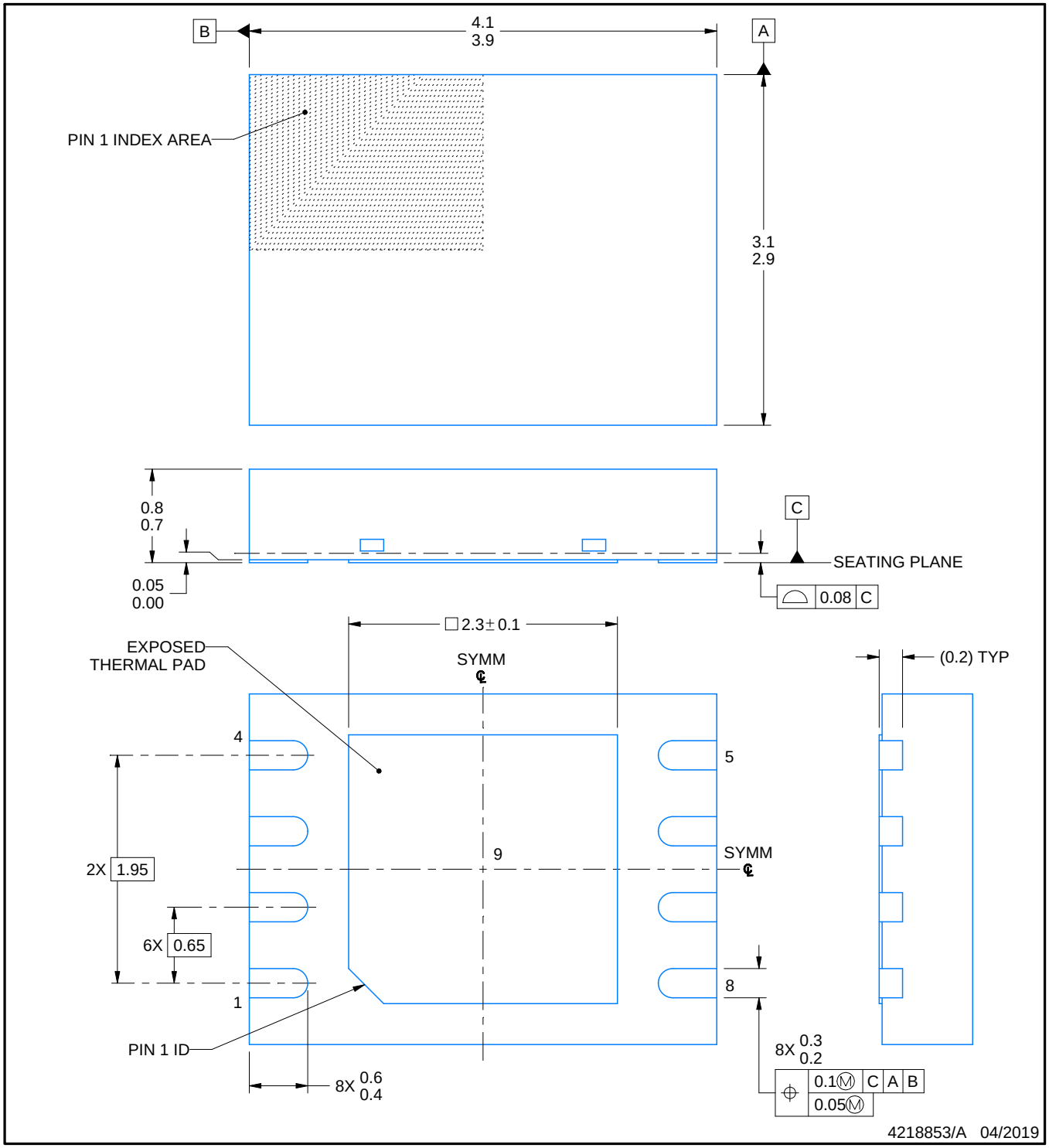
PACKAGE OUTLINE

DPJ0008A



WSON - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES:

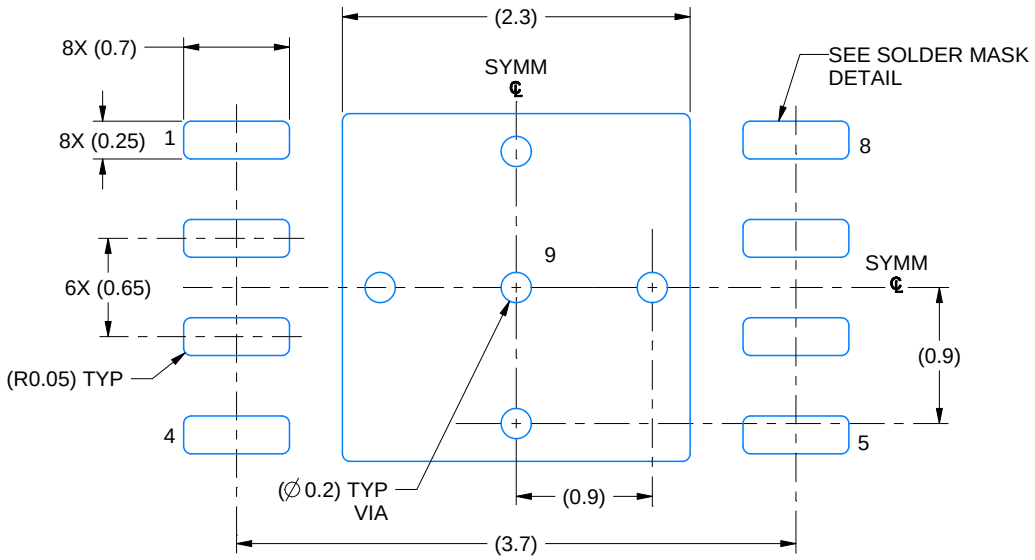
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

EXAMPLE BOARD LAYOUT

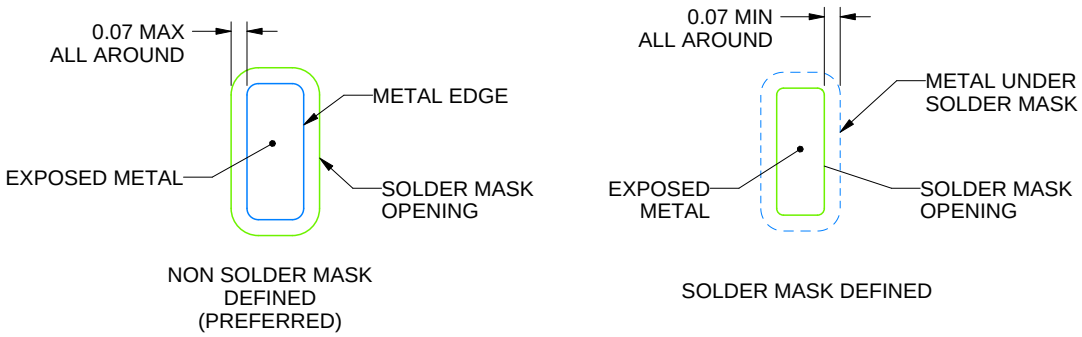
DPJ0008A

WSON - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 20X

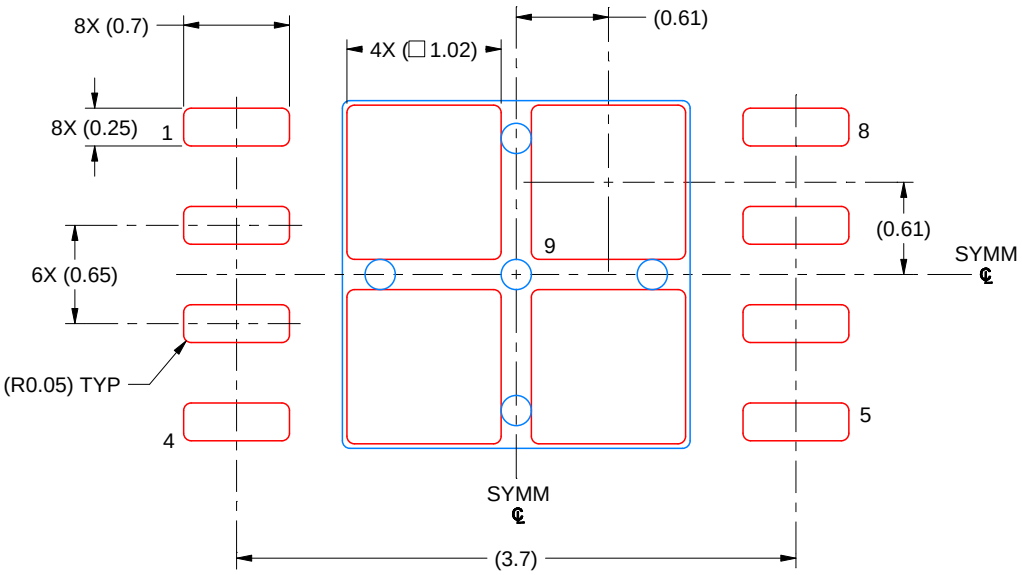


SOLDER MASK DETAILS

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NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



SOLDER PASTE EXAMPLE
BASED ON 0.125 MM THICK STENCIL
SCALE: 20X

EXPOSED PAD 9
79% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE

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NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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